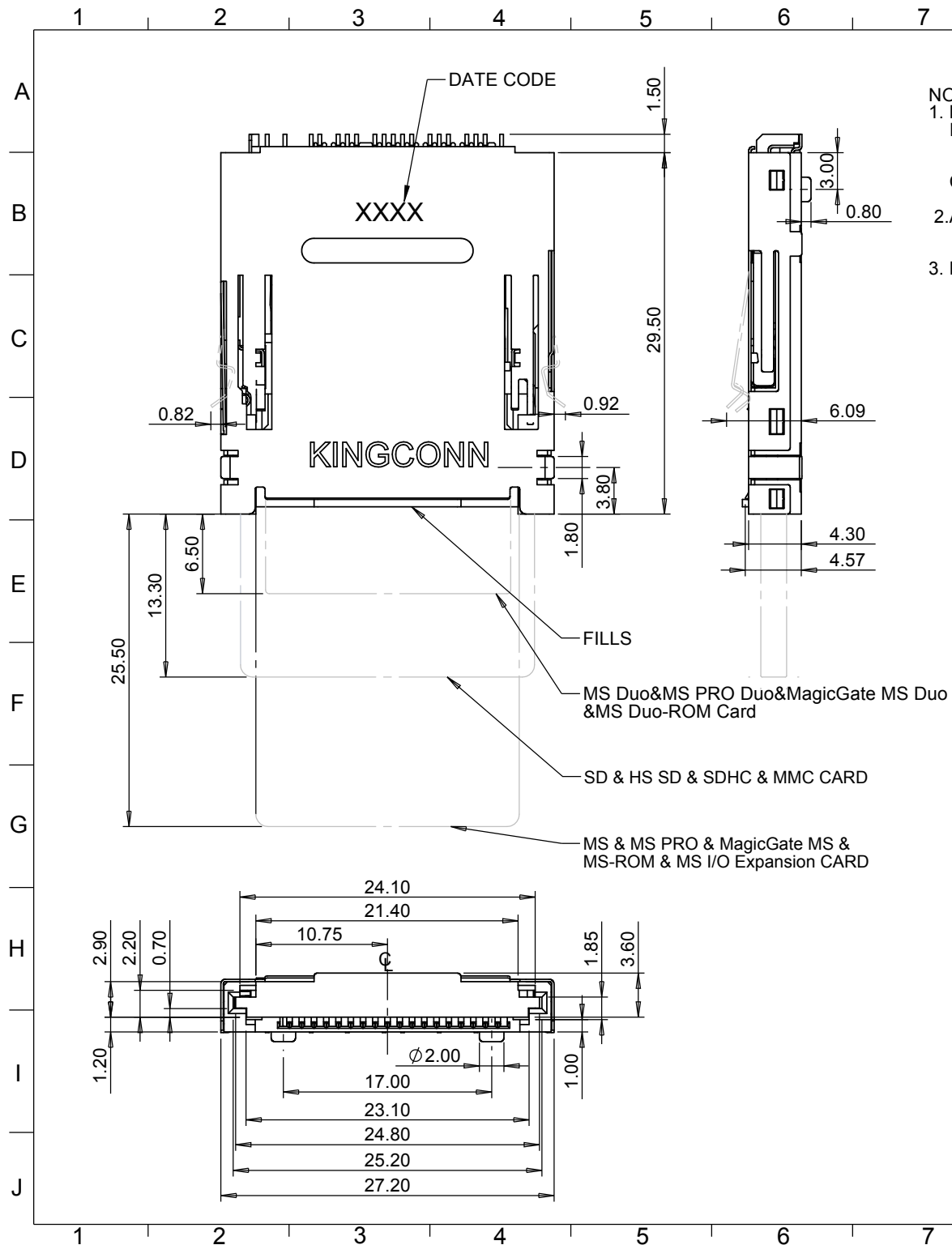




NOTES :

1. MATERIAL :

INSULATOR : HIGH TEMPERATURE
THERMOPLASTIC , UL94V-0.
COLOR : BLACK
CONTACT : PHOSPHOR BRONZE.

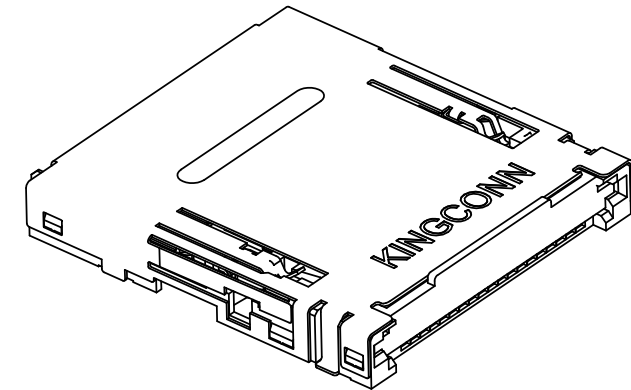
2.APPLICATION : SD&HS SD&SDHC&MMC&
MS&MS PRO&MagicGate MS&MS-ROM&MS I/O Expansion&
MS Duo&MS PRO Duo&MagicGate MS Duo&MS Duo-ROM Card

3. PART NO : 7ESMD-X0-X605

0:TRAY
1:REEL

– PLATING :

F CONTACT AREA :Gold Flash PLATED OVER Ni
SOLDER AREA : Tin PLATED OVER Ni
B CONTACT AREA :10μ" Au PLATED OVER Ni
SOLDER AREA : Tin PLATED OVER Ni



更改 REV	設 變 內 容 MODIFICATION
A	ECN03066
B	ECN03467
C	ECN04040

GENERAL TOLERANCE		KINGCONN 皇海科技股份有限公司 名 稱(TITLE) Multi-Card CONNECTOR	
X $\pm$ 0.50	X $^{\circ}\pm 5^{\circ}$		
.X $\pm$ 0.30	.X $^{\circ}\pm 2^{\circ}$		
.XX $\pm$ 0.20	.XX $^{\circ}\pm 1^{\circ}$		
單 位(UNIT)	料 號(PART NO.)	圖 號(DWG NO.)	
mm	7ESMD-X0-X605	7ESMD-X0-X605-C	
審 核(APPROVAL)	核 對(CHECKED)	製 圖(DRAWN)	比 例 SCALE 1:1 圖 號 SHEET 1 / 3 角 法 PRO.  更 改 REV C



